



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Larry D. Kinsman

Serial No.: 10/613,274

Filed: July 3, 2003

For: FLIP-CHIP IMAGE SENSOR PACKAGES AND METHODS OF

FABRICATION

Confirmation No.: 4369

Examiner:

Group Art Unit: 2814

Attorney Docket No.: 2269-5347.4US

(02-0171.04/US)

Notice of Allowance Mailed:

February 18, 2004

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

May 10, 2004 Date

Leah J. Barrow

Name (Type/Print)

AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

Mail Stop ISSUE FEE Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

Amendments to the Title appear on page 3 of this paper.

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Amendments to the Specification begin on page 4 of this paper.

Amendments to the Abstract appear on page 12 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 13 of this paper.

Amendments to the Drawings appear on page 16 of this paper and include both attached replacement sheets and annotated sheets showing changes.

Remarks begin on page 17 of this paper.

An **Appendix** including amended drawing figures is attached following page 17 of this paper.

IN THE TITLE:

The title has been amended herein. Pursuant to 37 C.F.R. §§ 1.121 and 1.125 (as amended to date), please enter the title as amended.

FLIP-CHIP IMAGE SENSOR PACKAGES-AND METHODS OF FABRICATION